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Silicon NPN Epitaxial

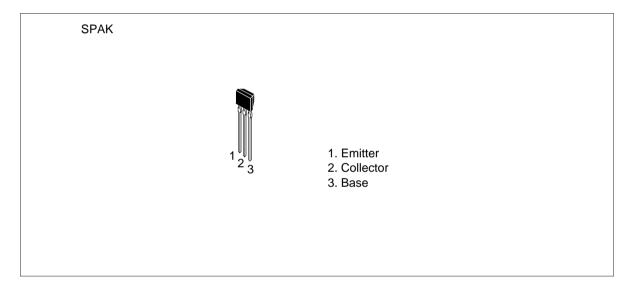


ADE-208-1158A (Z) 2nd. Edition Mar. 2001

#### Application

Low frequency amplifier, Muting

#### Outline



#### **Absolute Maximum Ratings** (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V <sub>CBO</sub>	30	V
Collector to emitter voltage	V <sub>CEO</sub>	15	V
Emitter to base voltage	V <sub>EBO</sub>	5	V
Collector current	Ι <sub>c</sub>	0.5	А
Collector peak current	ic (peak)	1.0	А
Collector power dissipation	Pc	300	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

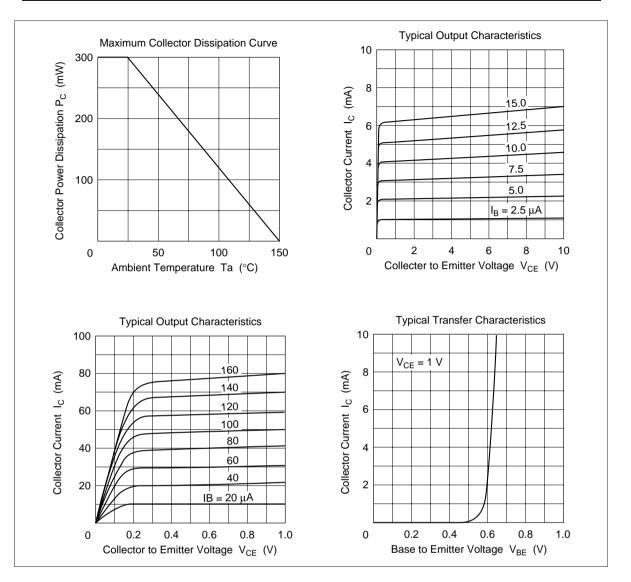
#### **Electrical Characteristics** (Ta = 25°C)

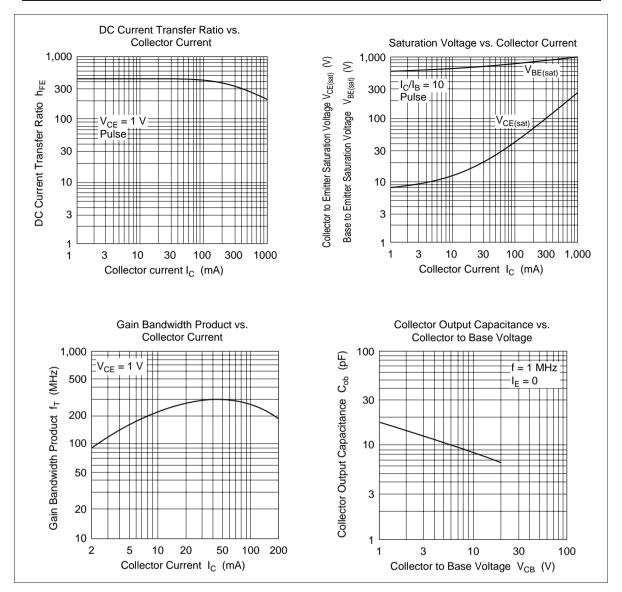
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\rm (BR)CBO}$	30	_	_	V	$I_{c} = 10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(\text{BR})\text{CEO}}$	15	_	_	V	$I_c = 1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(\text{BR})\text{EBO}}$	5	_	_	V	$I_{\rm E} = 10 \ \mu A, \ I_{\rm C} = 0$
Collector cutoff current	I <sub>CBO</sub>	_		10	μΑ	$V_{CB} = 20 \text{ V}, I_{E} = 0$
DC current transfer ratio	$h_{FE}^{*1}$	250		1200		$V_{ce} = 1 \text{ V}, I_c = 150 \text{ mA}^{*2}$
Base to emitter voltage	V <sub>BE</sub>		0.65	_	V	$V_{ce} = 1 \text{ V}, I_c = 150 \text{ mA}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	—	0.15	0.5	V	$I_c = 500 \text{ mA}, I_B = 50 \text{ mA}^{*2}$
	$V_{\text{CE(sat)}}$	_	0.018	_	V	$I_{c} = 30 \text{ mA}, I_{B} = 3 \text{ mA}$
Gain bandwidth product	f <sub>T</sub>	_	300	_	MHz	$V_{ce} = 1 \text{ V}, I_c = 50 \text{ mA}$
On resistance	r <sub>on</sub>		0.5		Ω	$I_{B} = 2 \text{ mA}$
Notes: 1. The 2SD1504 is grouped by $h_{rr}$ as follows.						

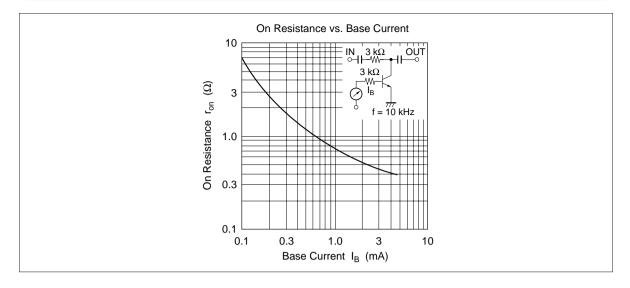
Notes: 1. The 2SD1504 is grouped by  $h_{FE}$  as follows.

Pulse test

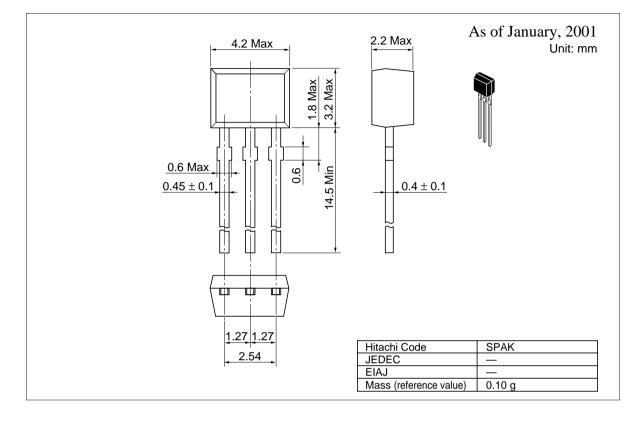
D	E	F
250 to 500	400 to 800	600 to 1200







#### **Package Dimensions**



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